



EUROPEAN SPACE AGENCY

ELEVATING THE FUTURE OF EUROPE

Systronic
Att. Mr. R. Faure
6 Avenue Atlantique
91940 Ullis (Les) France

Our ref: ESA-TECMSP-LE-2026-002839

VISA : T. Rohr (TEC-MSP)

Noordwijk, 16/10/2026


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by Thomas Rohr
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SUBJECT: SEQUENTIAL RIGID-FLEX POLYIMIDE PCB QUALIFICATION RENEWAL

Dear Mr. Faure,

Systronic submitted a sequential rigid-flex Polyimide PCB to ESA for qualification renewal in July 2026. The qualification results are reported in ESA-TECMSP-TR-2026-002483. No Deviations from the applicable requirements were identified during the inspection of the qualification board.

Systronic is therefore considered qualified in accordance with ECSS-Q-ST-70-60C for the manufacture of printed circuit boards within the qualification domain defined by the following Process Identification Document (PID).

- Sequential rigid-flex Polyimide PCB as defined in PID5 edition 13, until 01 October 2028

Best regards,

Simon
Fidder
Simon Fidder
Material, Manufacturing and Assembly section TEC-MSP


Digitally signed by Simon
Fidder
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